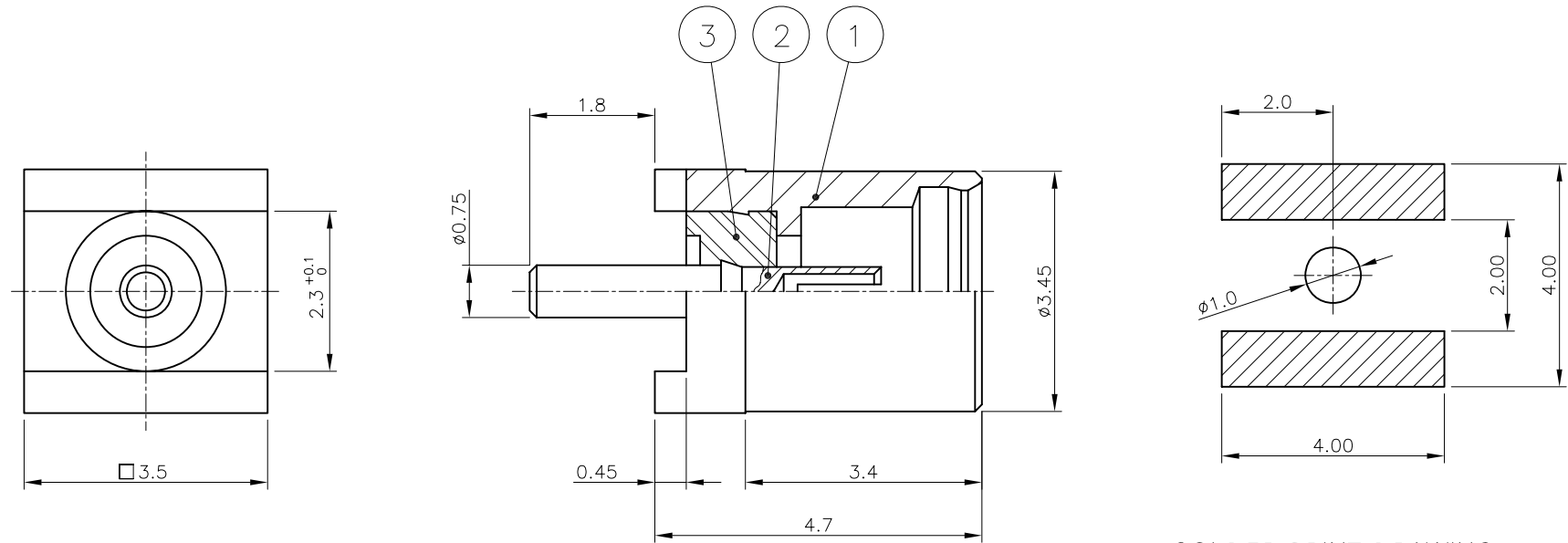


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2014.12.18.



SOLDER PRINT DRAWING

* NOTE.

1. BODY : 하지Ni 5 μm 이상 / Gold 0.06 μm 이상
2. CONTACT : 하지Ni 5 μm 이상 / Gold 1.27 μm 이상

3	INSULATOR	1	TEFLON		DIN01671-N/1
2	CONTACT	1	BeCu	Note.2	DCT03325-5/1
1	BODY	1	MBsBD	Note.1	DBD03807-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	±0.1	2014. 12. 18.				
	Angle	APPROVED BY		TITLE		
	±1°	CHECKED BY				
MATERIAL	_____	DRAWN BY		MMCX50-J-4R-R SMT		
		I.C.KIM				
FINISH	_____	SCALE	UNIT		A4	
		10/1	mm		DWG NO.	CN02479-7/2
					REVISION	I R SHEET 1 of 1